

TOSHIBA BIPOLAR LINEAR INTEGRATED CIRCUIT SILICON MONOLITHIC

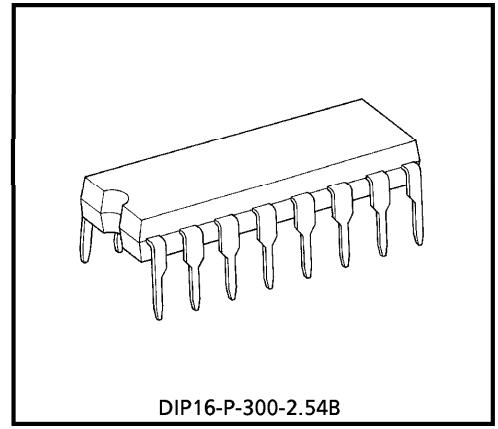
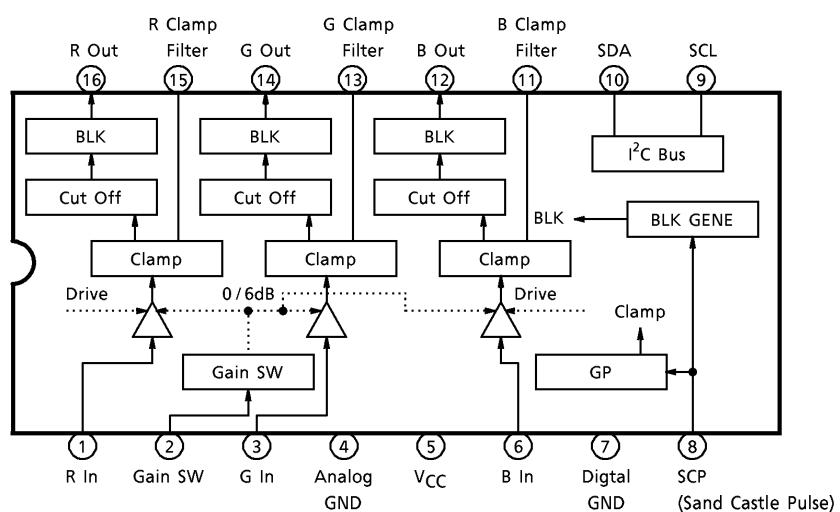
TA8889AP**RGB CUT OFF DRIVE CONTROL IC**

The TA8889AP is 16pin DIP package IC which has RGB Cut off/Drive control circuit.

The feature of TA8889AP is controlled via I²C bus.

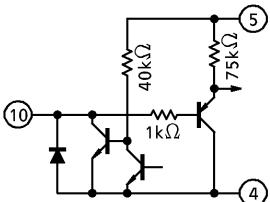
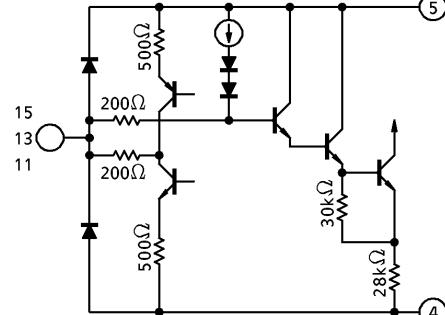
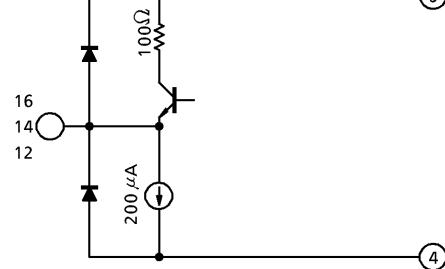
FEATURES

- 3 independents cut off control for 3 primary color.
- Independent drive control for blue and green color.
- 0dB / 6dB gain SW
- I²C bus interface circuit

**BLOCK DIAGRAM**

TERMINAL FUNCTION

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT
1	R In	These are primary color input terminals.	
3	G In	The signal which pedestal DC level is 2V should be inputted.	
6	B In		
2	Gain SW	This is the switch terminal for gain 0dB / 6dB and blanking pulse. Please refer gain SW mode table for detail.	
4	Analog GND	This is the GND terminal for analog circuit.	—
5	V _{CC}	This is common V _{CC} terminal for analog and digital circuit. The coupling capacitor should be connected between this terminal and digital GND.	—
7	Digital GND	This is GND terminal for I ² L circuit. The coupling capacitor should be connected between this terminal and digital GND.	—
8	S.C.P.	This is S.C.P. input terminal. The threshold level of clamp pulse is 6.5V and more (typ.), that of blanking pulse is 1.5V and less (typ.).	
9	SCL	This is SCL terminal for I ² C bus. Because its is weak for surge impulse, connect external devices for protection against surge if necessary.	

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT
10	SDA	This is SDA terminal for I ² C bus. Because its is weak for surge impulse, connect external devices for protection against surge if necessary.	
15 13 11	R Clamp Filter G Clamp Filter B Clamp Filter	This is the clamp filter terminal for R / G / B signal which is the signal after cut off and drive circuit.	
16 14 12	R Out G Out B Out	This is the R / G / B signal output terminal. We recommend its connects L.P.F. for removing high frequency noise.	

TERMINAL 2 (GAIN SW) OUTPUT MODE TABLE
 $(V_{CC} = 12V, Ta = \pm 3^{\circ}C)$

TERMINAL VOLTAGE	GAIN	BLANKING
V_{CC} (9.7V~ V_{CC})	6dB	Available
7.5V (6.7V~8.3V)		Not available
4.5V (3.7V~5.3V)	0dB	
GND (GND~2.3V)		Available

I²C BUS CONTROL MAP

- Slave address : 10011000 (98H)
- Sub address

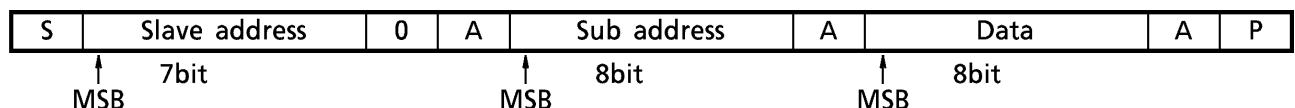
SUB ADDRESS	7	6	5	4	3	2	1	0	PRESET
00 (I)									Red color cut off control (10bit) LSB 00000000 (00H)
01 (II)	x	x	x	x	x	x	MSB ↑		00000000 (00H)
02 (I)									Green color cut off control (10bit) LSB 00000000 (00H)
03 (II)	x	x	x	x	x	x	MSB ↑		00000000 (00H)
04 (I)									Blue color cut off control (10bit) LSB 00000000 (00H)
05 (II)	x	x	x	x	x	x	MSB ↑		00000000 (00H)
06 (III)	MSB								Red color drive control (8bit) LSB 00000000 (00H)
07 (III)	MSB								Blue color drive control (8bit) LSB 00000000 (00H)

(Note) x bit : don't care

I²C BUS CONTROLLED FORMAT SUMMARY

Bus controlled format of TA8889AP is based on I²C bus control format of Philips.

Data transfer format

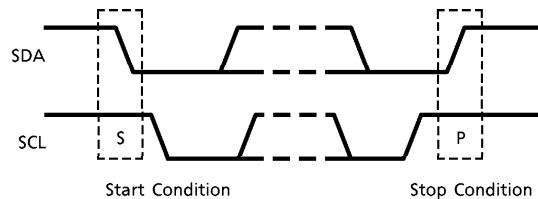


S : Start Condition

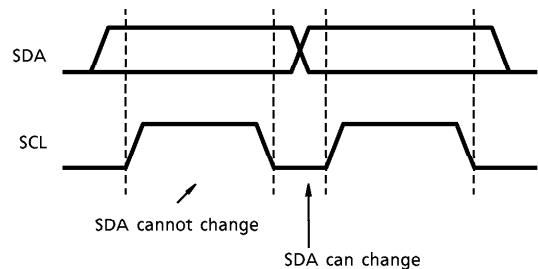
P : Stop Condition

A : Acknowledge

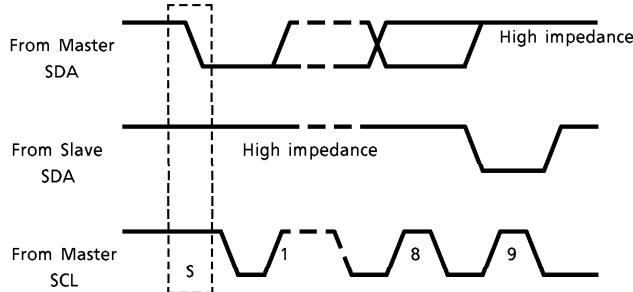
(1) Start and stop condition



(2) Bit transfer



(3) Acknowledge



(4) Slave address

A6	A5	A4	A3	A2	A1	A0	R / \bar{W}
1	0	0	1	1	0	0	0

Purchase of TOSHIBA I²C components conveys a license under the Philips I²C Patent Rights to use these components in an I²C system, provided that the system conforms to the I²C Standard Specification as defined by Philips.

MAXIMUM RATINGS (Ta = 25°C ± 3°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Power Supply Voltage	V _{CC}	15	V
Power Dissipation	P _D (Note 1)	1.4	W
Input Signal Voltage	e _{in}	7	V _{p-p}
Terminal Voltage	V _{in} (Note 2)	GND – 0.3~V _{CC} + 0.3	V
Operating Temperature	T _{opr}	-20~65	°C
Storage Temperature	T _{stg}	-65~150	°C

(Note 1) When using the device at above Ta = 25°C, decrease the power dissipation by 11.2mW for each increase of 1°C.

(Note 2) Rating of pin 9 and 10 is GND – 0.3V~5.5V.

RECOMMENDED SUPPLY VOLTAGE

PIN No.	PIN NAME	MIN.	TYP.	MAX.	UNIT
5	V _{CC}	10.8	12.0	13.2	V

ELECTRICAL CHARACTERISTICS

DC characteristics (Unless otherwise specified, V_{CC} = 12V, Ta = 25 ± 3°C)

CHARACTERISTIC	SYMBOL	TEST CIR-CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Power Supply Current	I _{CC}	—	Pin 1, 3, 6-DC 2V input Pin 8-S.C.P. input Pin 2-6dB MODE Sub address (I) = 00H (II) = 02H (III) = 80H	46	56	70	mA	
Terminal Voltage	V ₁₁	—		5.0	6.0	7.0	V	
	V ₁₂			2.8	3.0	3.2		
	V ₁₃			5.0	6.0	7.0		
	V ₁₄			2.8	3.0	3.2		
	V ₁₅			5.0	6.0	7.0		
	V ₁₆			2.8	3.0	3.2		

AC characteristics (Unless otherwise specified, $V_{CC} = 12V$, $T_a = 25 \pm 3^\circ C$)
Drive circuit

CHARACTERISTIC		SYMBOL	TEST CIR-CUIT	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
Frequency Characteristic		f_c	—	(Note 1)		10	20	30	MHz
Cross-talk		C_V	—	(Note 2)		45	50	—	dB
6dB Mode Gain	Max.	G6MA	—	(Note 3)	SA (III) : FFH	9.0	10.0	11.5	dB
	Typ.	G6TY			SA (III) : 80H	3.5	5.5	7.5	
	Min.	G6MI			SA (III) : 00H	1.0	2.0	3.0	
0dB Mode Gain	Max.	G0MA	—	(Note 4)	SA (III) : FFH	3.0	4.0	5.5	dB
	Typ.	G0TY			SA (III) : 80H	1.5	-0.5	-2.5	
	Min.	G0MI			SA (III) : 00H	-3.0	-4.0	-5.5	
Gain Control Range	Max.	GVMA	—	(Max. Gain / Min. Gain) - (Typ. Gain) Both 0 / 6dB mode	—	3.0	5.0	6.0	dB
	Min.	GVMI			—	3.0	3.5	4.0	
Input Dynamic Range	Max. DC	GIDA	—	(Note 5)	—	6.5	7.0	—	V
	Min. DC	GIDI			—	—	1.0	1.5	
Output Dynamic Range	Max. DC	VODA	—	(Note 6)	—	10.0	10.5	—	V
	Min. DC	VODI			—	—	1.0	1.5	

Cut off circuit

CHARACTERISTIC		SYMBOL	TEST CIR-CUIT	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
Min. Control Range		VLSB	—	(Note 7)		—	3.0	5.0	mV
DC Voltage Control Range	Max.	VCVI	—	(Note 8)	(I) (II) : FF03H	4.25	4.5	—	V
	Min.	VCVA			(I) (II) : 0000H	—	1.6	1.8	
	Range	VCV			(Max) - (Min)	2.5	2.9	—	
Center Off-set		VCOF	—	(Note 9)	(I) (II) : 0002H	0.8	1.0	1.2	V
Max. Input DC Level		VIMA	—		(I) (II) : 0000H	—	4.5	5.0	V
Min. Input DC Level		VIMI	(Note 10)	(I) (II) : FF03H	0.3	0.5	—		
Max. Output DC Level		VOMA		(I) (II) : FF03H	—	5.4	6.0		
Min. Output DC Level		VOMI		(I) (II) : 0000H	1.2	1.5	—		
Non Linear Point Value	SA : 7F00	VAC1	—	(Note 11)	—	—	—	3.0	mV
	SA : FF00	VAC2			—	—	—	3.0	
	SA : FF01	VAC3			—	—	—	3.0	

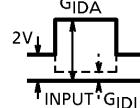
Threshold circuit

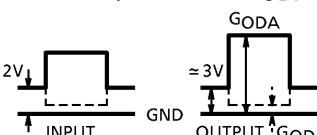
CHARACTERISTIC		SYMBOL	TEST CIR-CUIT	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
S.C.P. Threshold	GATE P	V_{GP}	—	—	—	6.2	6.5	6.8	V
	Hori. P	V_{HP}			—	1.2	1.5	1.8	
	Vert. P	V_{VP}			—	1.2	1.5	1.8	
Blanking Level	VBLNK	V_{BL}	—	(Note 12)		0.20	0.25	0.30	V

TEST CONDITION

Drive circuit

NOTE No.	ITEM	TERM-INAL 2 MODE	SUB ADDRESS & DATA			MEASUREMENT METHOD	
			(I)	(II)	(III)		
1	Frequency Characteristic	6dB (7.5V)	00H	02H	FFH	(1) Pin 1 (Pin 3, 6) : DC 4V. (2) Adjust the input voltage at Pin 15 (Pin 13, 11) to make Output voltage = 5.5V. (3) Pin 1 (Pin 3, 6) : 1MHz, 300mV _{p-p} , DC 4V, sine wave. Measure the output level (vout). (4) Measure the input level to make Output level = (vout - 3dB)	
2	Cross-talk	0dB (GND)	↑	↑	80H	(1) The same as Note 1. (2) The same as Note 1. (3) Pin 1 (Pin 3, 6) : 5MHz, DC 4V, sine wave. (4) Measure the cross-talk.	
3	6dB Mode Gain	Max.	6dB (7.5V)	↑	↑	FFH	(1) Pin 8 : S.C.P. or Gate pulse. (2) Pin 1 (Pin 6) : signal = (pedestal level = 2V, amplitude 3V). (3) Measure the output level. Calculate the 20log (output level / input level).
		Typ.				80H	
		Min.				00H	
4	0dB Mode Gain	Max.	0dB (GND)	↑	↑	FFH	(1) The same as Note 3. (2) Pin 1 (Pin 6) : signal = (pedestal level = 2V, amplitude 1.5V). (3) The same as Note 3.
		Typ.				80H	
		Min.				00H	
5	Input Dynamic Range	Max. DC	↑	↑	↑	00H	(1) The same as Note 3. (2) Pin 1 (Pin 6) : signal = (under Fig.) (3) Make input signal larger to output signal saturation level. Measure the input level. →GIDA (4) Make input signal smaller to output signal saturation level. Measure the input level. →GIDI
		Min. DC					

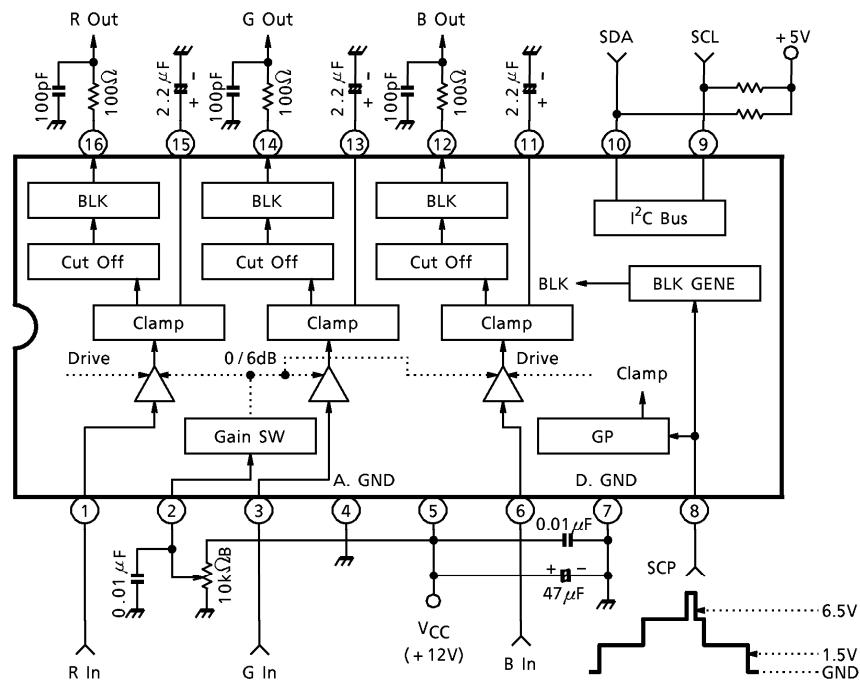


NOTE No.	ITEM	TERM- INAL 2 MODE	SUB ADDRESS & DATA			MEASUREMENT METHOD	
			(I)	(II)	(III)		
6	OUTPUT Dynamic Range	Max. DC	6dB (7.5V)	00H	02H	FFH	(1) Pin 8 : S.C.P. or Gate pulse. (2) Pin 1 (pin 6) : signal = (under Fig.) (3) Make input signal larger to output signal saturation level. Measure the output level. →GODA (4) Make input signal smaller to output signal saturation level. Measure the output level. →GODI 
		Min. DC					

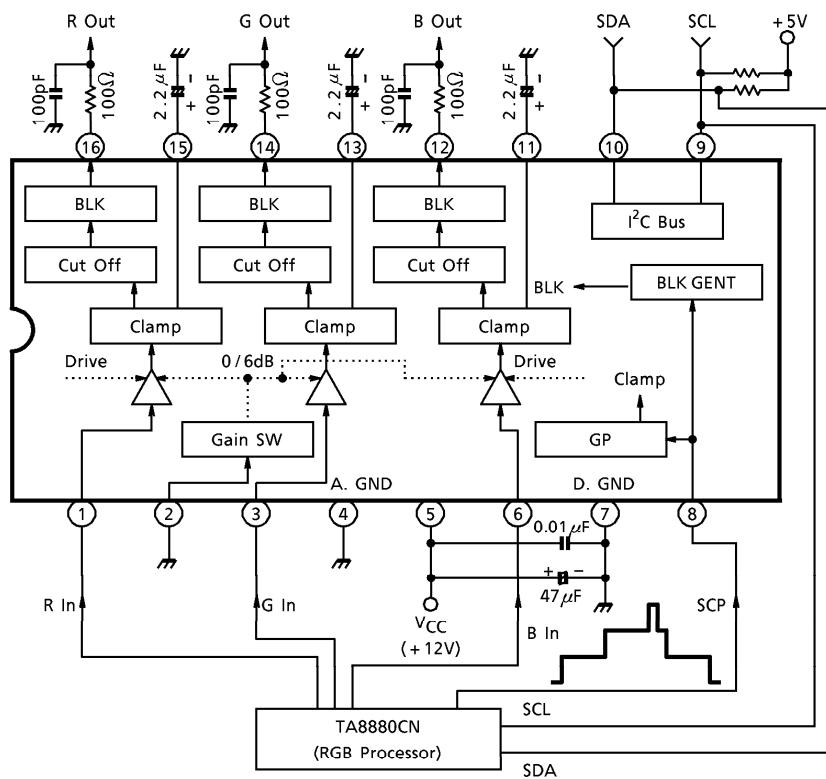
Cut off circuit

NOTE No.	ITEM	TERM- INAL 2 MODE	SUB ADDRESS & DATA			MEASUREMENT METHOD
			(I)	(II)	(III)	
7	Min. Variable Range	0dB (GND)	00H ↓ 01H	00H	80H	(1) The same as Note 6. (2) Pin 1 (Pin 3, 6) : DC 2V. (3) Subaddrss data (I) : 00H→01H. Measure the DC voltage gap of output DC level.
8	Control Range	Max.	↑	FFH	03H	(1) The same as Note 6. (2) The same as Note 7. (3) SA (I) (II) : FF03H, 0000H ; Measure the output DC level of each DATA.
		Min.		00H	00H	
9	Center Off-set	↑	00H	02H	↑	(1) The same as Note 6. (2) The same as Note 7. (3) (Output DC level) – (Input DC level 2V)
10	Max. Input DC Level	↑	00H	00H	↑	(1) The same as Note 6. (2) SA (I) (II) : 0000H ; Increase input DC level to output DC saturation level, Measure the input DC level. →VIMA (3) Decrease input DC level to output DC saturation level, Measure the output DC level. →VOMI (4) SA (I) (II) : FF03H ; Decrease input DC level to output DC saturation level, Measure the input DC level. →VIMI (5) Increase input DC level to output DC saturation level, Measure the output DC level. →VOMA
	Min. Input DC Level	↑	FFH	03H	↑	
	Max. Output DC Level	↑	00H	03H	↑	
	Min. Output DC Level	↑	FFH	03H	↑	
11	Non Liner Point Value	SA : 7F00	↑	7F00H ↓ 8000H	↑	(1) The same as Note 6. (2) Pin 1 (Pin 3, 6) : DC 2V. (3) SA (I) (II) : 7F00H→8000H, FF00H→0001H, FF01H→0002H ; Measure the DC voltage gap of each point.
		SA : FF00		7F00H ↓ 8000H		
		SA : FF01		7F00H ↓ 8000H		
12	Blanking Level	0dB (GND)	00H	02H	↑	(1) Pin 8 : S.C.P. or Gate pulse. (2) Pin 1 (Pin 3, 6) : DC 2V. (3) Measure The BLANKING LEVEL.

TEST CIRCUIT

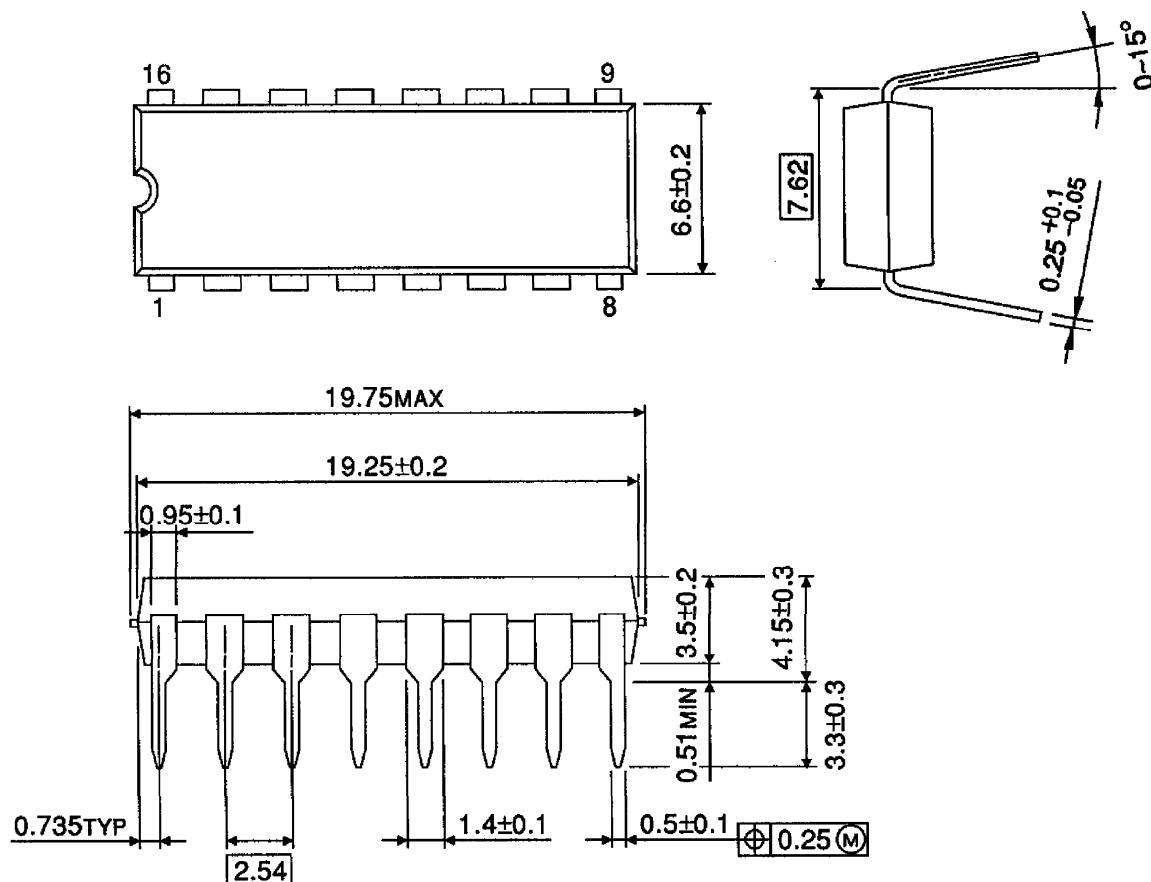


APPLICATION CIRCUIT



PACKAGE DIMENSIONS
DIP16-P-300-2.54B

Unit : mm



Weight : 1.11g (Typ.)

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000707EBA

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